TOSHIBA Rectifier Silicon Diffused Type

CRG09

General Purpose Rectifier Applications

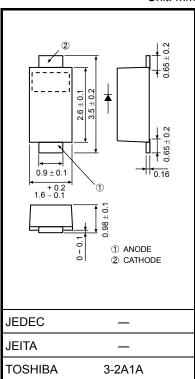
Unit: mm

- Repetitive peak reverse voltage: VRRM = 400 V
- Average forward current: IF (AV) = 1.0 A
- Forward voltage: $V_{FM} = 1.1 \text{ V (max)}$ (@I_{FM} = 0.7 A)
- High ESD Capability
- \bullet Suitable for high-density board assembly due to the use of a small surface-mount package, S–FLAT TM

Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Repetitive peak reverse voltage	V_{RRM}	400	V
Average forward current	I _{F(AV)}	1.0 (Note 1)	Α
Non-repetitive peak surge current	I _{FSM}	15 (50 Hz)	Α
Junction temperature	Тj	-40 to 150	°C
Storage temperature	T _{stg}	-40 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e.



Weight: 0.013 g (typ.)

operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Ta = 66°C

Device mounted on a ceramic board

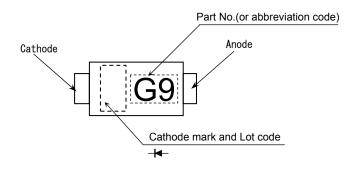
Board size: $50 \text{ mm} \times 50 \text{ mm}$ Soldering size: $2 \text{ mm} \times 2 \text{ mm}$ Board thickness: 0.64 mm

Electrical Characteristics (Ta = 25°C)

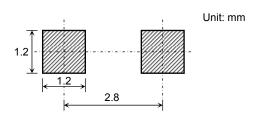
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit	
Peak forward voltage	V _{FM (1)}	I _{FM} = 0.1 A (pulse test)	_	0.83	_	V	
	V _{FM (2)}	I _{FM} = 0.7 A (pulse test)	_	0.95	1.1		
	V _{FM (3)}	I _{FM} = 1.0 A (pulse test)	_	1.00	_		
Repetitive peak reverse current	I _{RRM}	V _{RRM} = 400 V (pulse test)	_	_	10	μА	
Electrostatic Discharge Capability	ESD(1)	C = 150 pF , R = 2 k Ω , A contact electric discharge	_	25	_	kV	
	ESD(2)	C = 330 pF , R = 2 k Ω , A contact electric discharge	_	25	_	kV	
Thermal resistance (junction to ambient)	R _{th (j-a)}	Device mounted on a ceramic board (board size: 50 mm × 50 mm) (soldering land: 2 mm × 2 mm) (board thickness: 0.64 mm)	_	_	65	2CAM	
		Device mounted on a glass-epoxy board (board size: 50 mm × 50 mm) (soldering land: 6 mm × 6 mm) (board thickness: 1.6 mm)	_	_	130	°C/W	
Thermal resistance (junction to lead)	R _{th (j-l)}	_	_	_	20	°C/W	

Marking

Abbreviation Code	Part No.			
G9	CRG09			

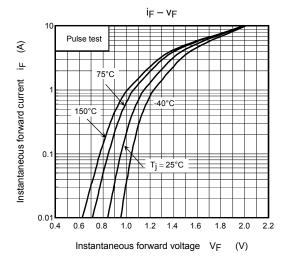


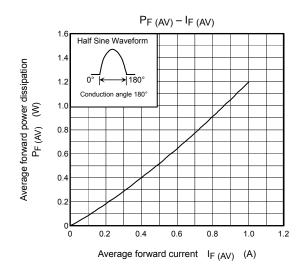
Land pattern dimensions for reference only

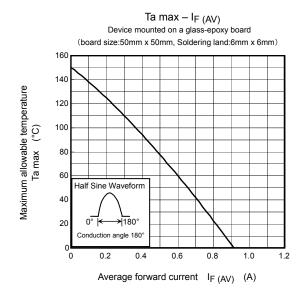


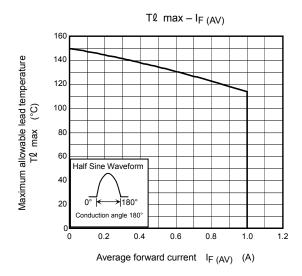
Handling Precaution

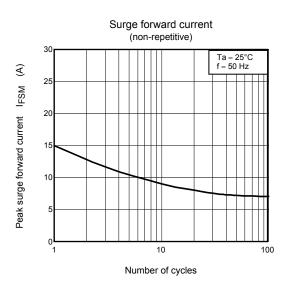
- 1) The absolute maximum ratings denote the absolute maximum ratings, which are rated values that must not be exceeded during operation, even for an instant. The following are the general derating methods that we recommend for designing a circuit incorporating this device.
- V_{RRM}: We recommend that the worst case voltage, including surge voltage, be no greater than 80% of the absolute maximum rating of V_{RRM} for a DC circuit and be no greater than 50% of that of V_{RRM} for an AC circuit. V_{RRM} has a temperature coefficient of 0.1%/°C. Take this temperature coefficient into account designing a device at low temperature.
- $I_{F(AV)}$: We recommend that the worst case current be no greater than 80% of the absolute maximum rating of $I_{F(AV)}$. Carry out adequate heat design. If you can't design a circuit with excellent heat radiation, set the margin by using an allowable Ta max- $I_{F(AV)}$ curve.
- I_{FSM}: This rating specifies the non-repetitive peak current. This is only applied for an abnormal operation, which seldom occurs during the lifespan of the device.
- T_j : Derate this rating when using a device in order to ensure high reliability. We recommend that a device be used at a T_j of below 120°C.
- 2) Thermal resistance between junction and ambient fluctuates depending on the device's mounting condition. When using a device, design a circuit board and a soldering land size to match the appropriate thermal resistance value.
- 3) Please refer to the Rectifiers databook for further information.

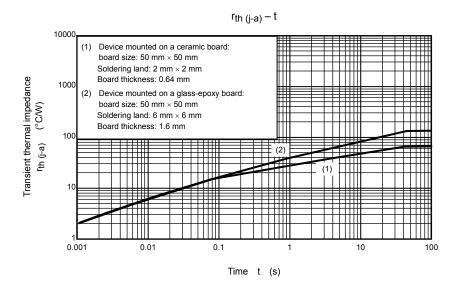












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